

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Yibo Jiang</td> <td>07/19/2012</td> </tr> <tr> <td>Sharad Deepak Sambhwani</td> <td>07/24/2012</td> </tr> <tr> <td>Jilei Hou</td> <td>07/16/2012</td> </tr> <tr> <td>Jibing Wang</td> <td>07/30/2012</td> </tr> </tbody> </table>		Name	Execution Date	Yibo Jiang	07/19/2012	Sharad Deepak Sambhwani	07/24/2012	Jilei Hou	07/16/2012	Jibing Wang	07/30/2012
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Yibo Jiang	07/19/2012										
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Jibing Wang	07/30/2012										
RECEIVING PARTY DATA											
Name:	QUALCOMM Incorporated										
Street Address:	5775 Morehouse Drive										
City:	San Diego										
State/Country:	CALIFORNIA										
Postal Code:	92121-1714										
PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13019448</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13019448						
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Application Number:	13019448										
CORRESPONDENCE DATA											
Fax Number:	8586582502										
Phone:	8586582389										
Email:	US-Docketing@Qualcomm.com										
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>											
Correspondent Name:	QUALCOMM Incorporated										
Address Line 1:	5775 Morehouse Drive										
Address Line 4:	San Diego, CALIFORNIA 92121-1714										
ATTORNEY DOCKET NUMBER:	100860										
NAME OF SUBMITTER:	Judy Bridgwater										
Total Attachments: 12											

CH \$40.00 13019448

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ASSIGNMENT

WHEREAS, WE,

1. **Yibo Jiang**, a citizen of China, having a mailing address located at 5775 Morehouse Drive, San Diego, California, USA 92121; and a resident of San Diego, CA,
2. **Sharad Deepak Sambhwani**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, USA 92121; and a resident of San Diego, CA,
3. **Jilei Hou**, a citizen of China, having a mailing address located at 5775 Morehouse Drive, San Diego, California, USA 92121; and a resident of Beijing, China,
4. **Jibing Wang**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, USA 92121; and a resident of San Diego, CA,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **APPARATUS AND METHOD FOR ENABLING UPLINK BEAMFORMING TRANSIT DIVERSITY** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS under the Patent Cooperation Treaty (PCT) or in the United States, including but not limited to International Patent Application No(s). **13/019,448**, filed February 02, 2011, Qualcomm Reference No. 100860, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). **61/302,056**, filed February 05, 2010, Qualcomm Reference No. 100860P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all nonprovisional applications, national phase applications, divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all

reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at San Diego, on 7/19/12
LOCATION DATE


Yibo Jiang

Done at _____, on _____
LOCATION DATE

Sharad Deepak Sambhwani

Done at _____, on _____
LOCATION DATE

Jilei Hou

Done at _____, on _____
LOCATION DATE

Jibing Wang

ASSIGNMENT

WHEREAS, WE,

1. **Yibo Jiang**, a citizen of China, having a mailing address located at 5775 Morehouse Drive, San Diego, California, USA 92121; and a resident of San Diego, CA,
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have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **APPARATUS AND METHOD FOR ENABLING UPLINK BEAMFORMING TRANSIT DIVERSITY** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS under the Patent Cooperation Treaty (PCT) or in the United States, including but not limited to International Patent Application No(s). **13/019,448**, filed February 02, 2011, Qualcomm Reference No. 100860, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). **61/302,056**, filed February 05, 2010, Qualcomm Reference No. 100860P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all nonprovisional applications, national phase applications, divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all

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AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
LOCATION DATE Yibo Jiang

Done at SAN DIEGO, on 7/24/2012
LOCATION DATE Sharad Deepak Sambhwani

Done at _____, on _____
LOCATION DATE Jilei Hou

Done at _____, on _____
LOCATION DATE Jibing Wang

ASSIGNMENT

WHEREAS, WE,

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Done at _____, on _____
LOCATION DATE
Yibo Jiang

Done at _____, on _____
LOCATION DATE
Sharad Deepak Sambhwani

Done at Beijing, China, on 07/16/2012
LOCATION DATE

Jilei Hou

Done at _____, on _____
LOCATION DATE
Jibing Wang

ASSIGNMENT

WHEREAS, WE,

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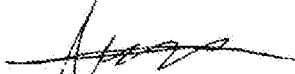
AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

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Done at _____, on _____
LOCATION DATE Yibo Jiang

Done at _____, on _____
LOCATION DATE Sharad Deepak Sambhwani

Done at _____, on _____
LOCATION DATE Jilei Hou

Done at San Diego, on 07/30/2012
LOCATION DATE 
Jibing Wang